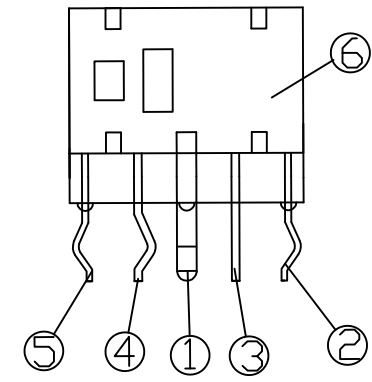
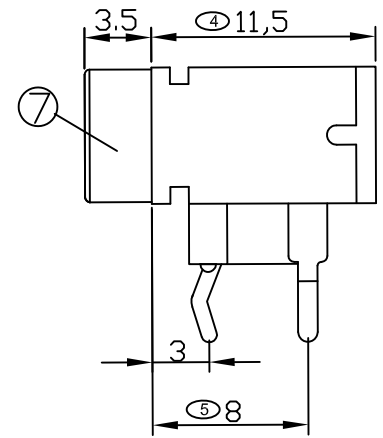
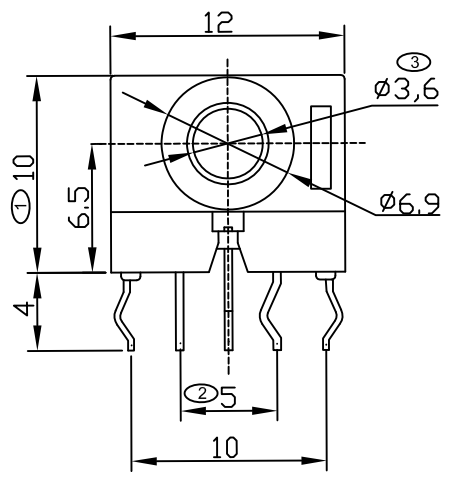


SPECIFICATION

1. Rating : DC 30V 0.5A;
2. Contact resistance: $\leq 30\text{m}\Omega$;
3. Insulation resistance: $\geq 100\text{M}\Omega$;
4. Withstand voltage: 500VAC ;
5. Insertion and extraction force: 3-30N;
6. life test: 5,000 cycles.

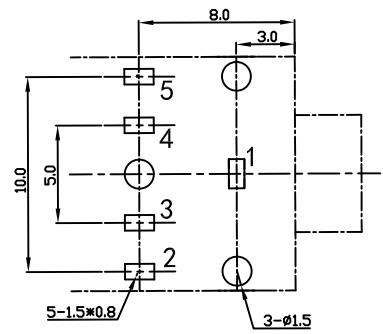
※ SIGN “(X)” IS IMPORTANCE DIMENSION



Model No.	KPJD-3017-5A-3.5	KPJD-3017-4B-3.5	KPJD-3017-3D-3.5	KPJD-3017-3C-3.5
Schematic code				

⑦	底座HOUSING	1	PBT	黑色BLACK
⑥	盖子COVER	1	PBT	黑色BLACK
⑤	5#脚CONTCAT	1	磷铜T=0.3	镀银Ag-Plating
④	4#脚CONTCAT	1	黄铜T=0.4	镀银Ag-Plating
③	3#脚CONTCAT	1	黄铜T=0.4	镀银Ag-Plating
②	2#脚CONTCAT	1	磷铜T=0.3	镀银Ag-Plating
①	1#脚CONTCAT	1	磷铜T=0.5	镀锡Sn-Plating
NO.	DESCRIPTION	QTY	MATERIAL	PLATING

1:1.6 Dimensions of PC board holes
Tolerance : ± 0.1 (Printed-sided view)



KEM 奇速科技有限公司 Qi-Speed Technology CO., LTD.					產品名稱: PHONE JACK	
單位: mm		繪圖	設計	審核	核准	料號: KPJD-3017-XX-3.5
比例:		DRAWING	DESIGNED	CHECKED BY	APPROVAL BY	PART NUMBER
公差: X. ± 0.38 .X ± 0.25 .XX ± 0.13		JOHNY	JOHNY	LUKE	JAMES	圖號: KPJD-3017-XX-3.5-1
日期: 2021/5/8						DRAWING NO
版本	修改事項	修改日期				版本: REV. 0